U.S. Patent and Tradement Office; U.S. DEPARTMENT OF COMMERCIE

EISSUE APPLICATION DECLARATION BY THE INVENTOR

Docket Number (Optional)

T.S. 977 - 306

REISSUE APPLICATION DECLARATION BY THE INVENTOR

	1 107.1-306
	As a below named inventor, I hereby declare that:  My residence, mailing address and citizenship are stated below next to my name.  I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is described and claimed in patent number 601906, granted FEB 1,2000, and for which a reissue patent is sought on the invention entitled HARD MASKING METHOD FOR THE MILL PATIENTED OXYGEN CONTAINING PLASMA ETCHABLE the specification of which
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	I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxos that apply.)  Dy reason of a defective specification or drawing.
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REISSUE APPLICATION: CONSENT OF ASSIGNEE; STATEMENT OF NON-ASSIGNMENT	Docket Number (Optional)	
	TS97-306	-
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atent Number ( COLD COLD TANG) M	ING-HSIN HUANG	-
itle of Invention	PB. ( Znnn	
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2. Ownership of the nates in its the	O/SB/96)	ILP
2. Ownership of the patent is in the inventor(s), and no assignment	ent of the patent is in effect.	-
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are written consent of all assignees and inventors owning an undivided interest is included in this application for reissue.  The assignee(s) owning an undivided interest in said original patent is/are and the assignee(s) consents to the accompanying application for reissue.  The of assignee/inventor (if not assigned)  Thur is a supplication of the accompanying application for reissue.  Date  Date	TALWAN SEMICONDUC MANUFACTURING COMP	TON?
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STATEMENT UNDER 37 CFR 3.73(b)			
ApplicantiPatent Owner: TAIWON SEMILLOWOVOTEN MANYFACTURING COMPANY			
Application No. Patent No.: 10 1 1 10 6			
Entitled: HARD MASKING METHOD FOR FORMING PATTONION OXYCELL COOP			

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	States that it is:	
	1. It the assignee of the entire right, title, and interest; or	
	2. I are assignee of less than the entire right, title and interest. The extent (by, percentage) of its ownership interest is%	
	in the patent application/patent identified above by virtue of either.	
	A. b() An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Real, Frame, or for which a copy thereof is attached.	
	OR 1921 0364	
	B. [ ] A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:	
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	2. From:To:	
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	3. From:	
	The document was recorded in the United States Patent and Trademark Office at Reel, Frame, or for which a copy thereof is attached.	
	[ ] Additional documents in the chain of title are fisted on a supplemental sheet.	
	[ ] Copies of assignments or other documents in the chain of title are attached.  [NOTE: A separate copy (i.e., the original assignment document or a true copy of the original document) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the USPTO. See MPEP 302.08]	
ł	The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.	
	Dote RicHARD L. Thurston	
j	Signature	
	SPNERAL COUNSEL, UP	
B	Title	

Builden Hour Statement: This fours is estimated to take 0.2 hours to complete. Time will vary depending upon me mode of the inervidual case. Any comments on the amount of time you are required to complete this form should be were to the Chief Information Officer, U.S. Fraters and Trademark. Officer, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS, SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.

PTO/SB/32 (02-01)

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U.S. Patrini and Tradeniark Office; U.S. DEPARTMENT OF COMMERCE

REISSUE APPLICATION DECLARATION BY THE ASSIGNEE TO 97-306.  I hereby declare that:  My residence and mailing address and citizenship are stated below next to my name.  I am authorized to act on behalf of the following assignee: TALWAN SETTICENMOVER MANUFACTURING and the title of my position with said assignee is.  The entire title to the patent identified below is vested in said assignee.  Name of Patentse(s):  SYUN - MING JANG, MING-HSIN HUANG  Patent Number  Oble of Patent Issued  FEG. 1, ZDUD  Title of Invention  HARD MASKING METHOD FOR FORMING PATTERNED DRYGEN CONTAINING	Under the Paperwork Padugtion Act of 1995, no paraons are required to respond to a collection of information unities it displays a valid CMB control number.
My residence and mailing address and citizenship are stated below riest to my name.  I am authorized to act on behalf of the following assignoe: TALWAN SCRICDMOVERS MANUFACTURING and the title of my position with said assignee is.  The entire title to the patent identified below is vested in said assignee.  Mame of Patentsets:  SYUN MING JANG MING—HIN HUANG  Patent Number  C. DIP, 906 Diste of Patent issued  Tale of invanion  The of patent issued  Tale of patent issued  Tale of patent issued  Tale of invanion  The ming patentee(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the Invantion entitled  the specification of which  I is attached hereto.  Was filed on as reissue application number and was amended on and was amended on and was amended on as reissue application number.  I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid. For the reasons described below. (Check at the original patent to be wholly or partly inoperative or invalid. For the reasons described below. (Check at the original patent to be wholly or partly inoperative or invalid. For the reasons described by reason of the patentee claiming more or less than the had the right to claim in the patent.  By reason of other errors.  At least one error upon which reissue is based is described as follows:  THE SPECIFICATION OF CLOSED RUT DOES NUT CLAIM THAT  THE UNIFIED AND CUNTAIN NO FLOSIMA ETCHNOLE MICRORIZEM CONTAIN	REISSUE APPLICATION DECLARATION BY THE ASSIGNEE TS 97 - 306
The entire title of my position with said assignce is.  The entire title to the patent identified below is vested in seid assignce.  Name of Patentsets:  SYUN - MING JANG, MING-HIN HUANG-  Patent Number  Patent Number  Patent Number  Patent Number  Title of invention  HARO MASKING METARD FOR FORMING PATTERNED DAYGEN CONTAINING  I believe said patentse(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the Invention entitled  the specification of which  is attached hereto.  I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)  Dy reason of a defective specification or drawing.  By reason of the patentee claiming more or less than the had the right to claim in the patent.  The SPECIFICATION OIS CLOSID RUT DOWN NOT CLAIM THAT THE OXYGEN CUNTAINING PLANAE ETCHROLE MICRORY EXTRANCE LAYER MAY CUMPARILE A JPIN -ON METER 1.00.	1
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In entire title to the patent identified below is vested in seld assignee.  Name of Patentee(s):  SYUN - MING JANG, MING-HSIN HUANG  Patent Number  C 019,906  Date of Patent Issued  FEG 1 ZOUD  Title of invariation  HARD MASKING METHOD FOR FORMING PATTERNED DAYGEN CONTAINING  I believe said patentee(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the Invention entitled  the specification of which  I is attached hereto.  was filed on as reissue application number   I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)  Dy reason of a defective specification or drawing.  By reason of the patentee claiming more or less than the had the right to claim in the patent.  Dy reason of other errors.  At least one error upon which reissue is based is described as follows:  THE SPECIFICATION DISCLOSID RUT DOWS NUT CLAIM THAT THE OXYGEN CUMPRUSE A JPIN DRIM ETCNOBLE MICRORALEUTOWN CS (Attach additional sheets, if needed 1	I am authorized to act on behalf of the following assignos: IAIWAN SETTICENDVCTOR MANU FOCTIVE
In entire title to the patent identified below is vested in seld assignee.  Name of Patentee(s):  SYUN - MING JANG, MING-HSIN HUANG  Patent Number  C 019,906  Date of Patent Issued  FEG 1 ZOUD  Title of invariation  HARD MASKING METHOD FOR FORMING PATTERNED DAYGEN CONTAINING  I believe said patentee(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the Invention entitled  the specification of which  I is attached hereto.  was filed on as reissue application number   I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)  Dy reason of a defective specification or drawing.  By reason of the patentee claiming more or less than the had the right to claim in the patent.  Dy reason of other errors.  At least one error upon which reissue is based is described as follows:  THE SPECIFICATION DISCLOSID RUT DOWS NUT CLAIM THAT THE OXYGEN CUMPRUSE A JPIN DRIM ETCNOBLE MICRORALEUTOWN CS (Attach additional sheets, if needed 1	and the title of my position with said assignee is.
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the specification of which  is attached hereto.  was filed on as reissue application number/  I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.  I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all buxes that apply.)  by reason of a defective specification or drawing.  by reason of the patentee claiming more or less than he had the right to claim in the patent.  by reason of other errors.  At least one error upon which reissue is based is described as follows:  THE SPECIFICATION DISCLOSIO BUT DOES NOT CLAIM THAT THE OXYGEN CONTAINING PLASMA ETCHABLE MICROPLETOMICS LAYER MAY CUMPRUSE A JPIN ON MITTER INC.  [Attach additional sheets, if needed 1]	described and claimed in said patent for which a reissure patent in
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